

MH180 Hall-effect sensor is a temperature stable, stress-resistant sensor. Superior high-temperature performance is made possible through a dynamic offset cancellation that utilizes chopper-stabilization. This method reduces the offset voltage normally caused by device over molding, temperature dependencies, and thermal stress.

MH180 includes the following on a single silicon chip: voltage regulator, Hall voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, Pull-up resistor output. Advanced DMOS wafer fabrication processing is used to take advantage of low-voltage requirements, component matching, very low input-offset errors, and small component geometries.

This device requires the presence of both south and north polarity magnetic fields for operation. In the presence of a south polarity field of sufficient strength, the device output sensor on, and only switches off when a north polarity field of sufficient strength is present.

MH180 is rated for operation between the ambient temperatures  $-40^{\circ}\text{C}$  and  $85^{\circ}\text{C}$  for the E temperature range, and  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  for the K temperature range. The two package styles available provide magnetically optimized solutions for most applications. Package SO is an SOT-23, a miniature low-profile surface-mount package ; Package SF is an SOT89-5L, a low-profile surface-mount package, while package UA is a three-lead ultra mini SIP for through-hole mounting.

Packages is Halogen Free standard and which have been verified by third party lab.


### ***Features and Benefits***

- DMOS Hall IC Technology.
- Reverse bias protection on power supply pin.
- Chopper stabilized amplifier stage.
- Optimized for BLDC motor applications.
- Reliable and low shifting on high Temp condition.
- Switching offset compensation at typically 69 kHz.
- Good ESD Protection.
- 100% tested at  $125^{\circ}\text{C}$  for K.
- Custom sensitivity / Temperature selection are available.
- RoHS compliant 2011/65/EU and Halogen Free

### ***Applications***

- High temperature Fan motor
- 3 phase BLDC motor application
- Speed sensing
- Position sensing
- Current sensing
- Revolution counting
- Solid-State Switch
- Linear Position Detection
- Angular Position Detection
- Proximity Detection
- High ESD Capability

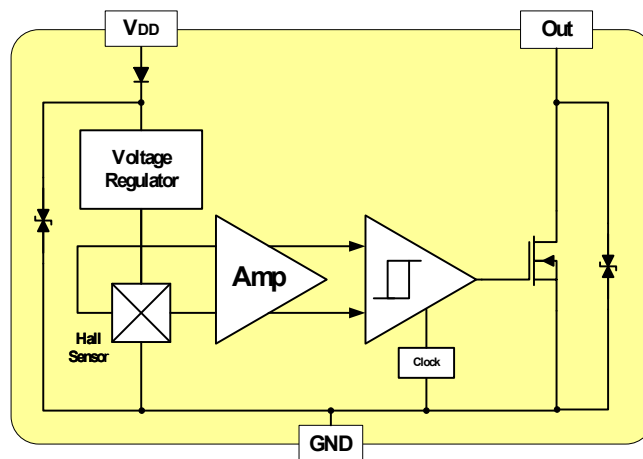
### Ordering Information

	<p><b>Company Name and Product Category</b> MH:MST Hall Effect/MP:MST Power IC</p> <p><b>Part number</b> 181,182,183,184,185,248,249,276,477,381,381F,381R,382..... If part # is just 3 digits, the forth digit will be omitted.</p> <p><b>Temperature range</b> E: 85 °C, I: 105 °C, K: 125 °C, L: 150 °C</p> <p><b>Package type</b> UA:TO-92S,VK:TO-92S(4pin),VF:TO-92S(5pin),SO:SOT-23, SQ:QFN-3,ST:TSOT-23,SN:SOT-553,SF:SOT-89(5pin), SS:TSOT-26,SD:DFN-6</p> <p><b>Sorting</b> α,β,Blank.....</p>
---	---

Part No.	Temperature Suffix	Package Type
MH180KUA	K (-40°C to + 125°C)	UA (TO-92S)
MH180KSO	K (-40°C to + 125°C)	SO (SOT-23)
MH180EUA	E (-40°C to + 85°C)	UA (TO-92S)
MH180ESO	E (-40°C to + 85°C)	SO (SOT-23)
MH180KSF	E (-40°C to + 125°C)	SF (5-pin SOT-89)

*KUA spec is using in industrial and automotive application. Special Hot Testing is utilized.*

### Functional Diagram



#### Absolute Maximum Ratings At ( $T_A=25^{\circ}\text{C}$ )

Characteristics		Values	Unit
Supply voltage, ( $V_{DD}$ )		28	V
Output Voltage, ( $V_{out}$ )		28	V
Reverse voltage, ( $V_{DD}$ )		-28	V
Magnetic flux density		Unlimited	Gauss
Output current, ( $I_{SINK}$ )		50	mA
Operating Temperature Range, ( $T_a$ )	“E” version	-40 to +85	$^{\circ}\text{C}$
	“K” version	-40 to +125	$^{\circ}\text{C}$
Storage temperature range, ( $T_s$ )		-65 to +150	$^{\circ}\text{C}$
Maximum Junction Temp, ( $T_j$ )		150	$^{\circ}\text{C}$
Thermal Resistance	( $\theta_{ja}$ ) UA / SO/ SF	206 / 543/ 156	$^{\circ}\text{C}/\text{W}$
	( $\theta_{jc}$ ) UA / SO/ SF	148 / 410/ 34	$^{\circ}\text{C}/\text{W}$
Package Power Dissipation, ( $P_D$ ) UA / SO/ SF		606 / 230 / 800	mW

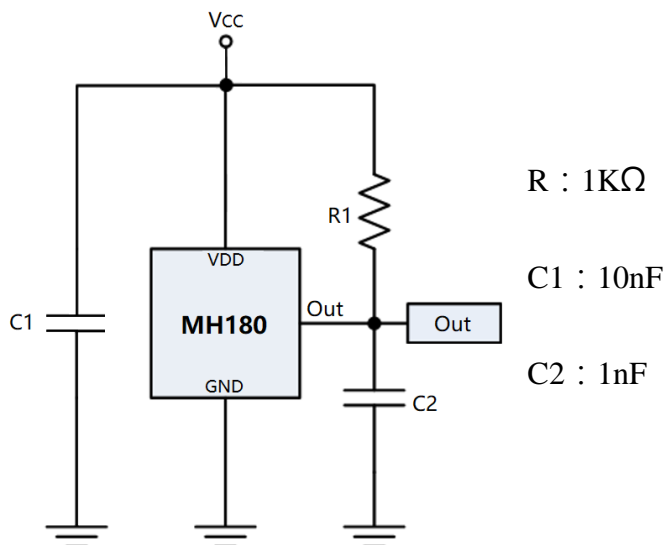
*Note: Do not apply reverse voltage to  $V_{DD}$  and  $V_{OUT}$  Pin, It may be caused for Miss function or damaged device.*

#### Electrical Specifications

DC Operating Parameters:  $T_A=+25^{\circ}\text{C}$ ,  $V_{DD}=12\text{V}$

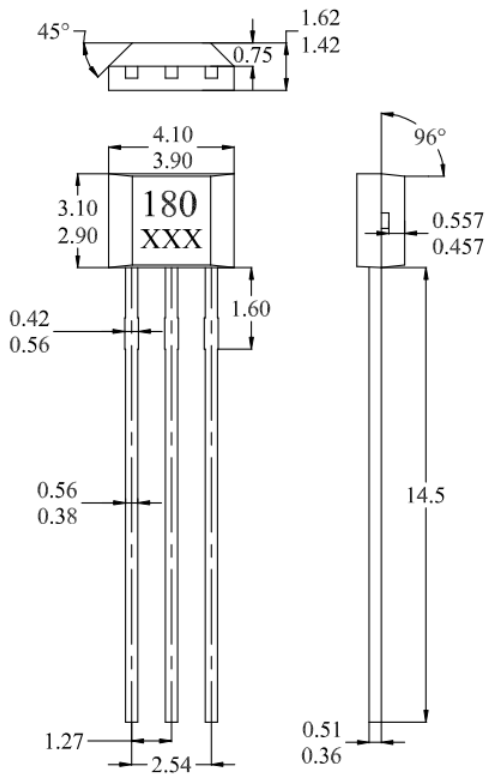
Parameters	Test Conditions	Min	Typ	Max	Units
Supply Voltage, ( $V_{DD}$ )	Operating	2.5		24.0	V
Supply Current, ( $I_{DD}$ )	$B < B_{OP}$			5.0	mA
Output Saturation Voltage, ( $V_{sat}$ )	$I_{OUT} = 20\text{ mA}$ , $B > B_{OP}$			400.0	mV
Output Leakage Current, ( $I_{off}$ )	$I_{OFF} B < BRP$ , $V_{OUT} = 12\text{V}$			10.0	$\mu\text{A}$
Internal Oscillator Chopper Frequency, ( $f_{osc}$ )			69		kHz
Output Rise Time, ( $T_R$ )	$R_L=1.1\text{K}\Omega$ , $C_L=20\text{pF}$		0.04	0.45	$\mu\text{s}$
Output Fall Time, ( $T_F$ )	$R_L=820\Omega$ ; $C_L=20\text{pF}$		0.18	0.45	$\mu\text{s}$
Electro-Static Discharge	HBM	4			KV
Operate Point, ( $B_{OP}$ )	UA, SF, SO	10	50	90	Gauss
Release Point, ( $B_{RP}$ )	UA, SF, SO	90	-50	-10	Gauss
Hysteresis, ( $B_{HYS}$ )			100		Gauss

#### Typical application circuit

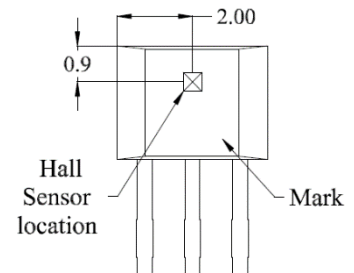


### Sensor Location, Package Dimension and Marking

#### UA Package



#### Hall Chip location

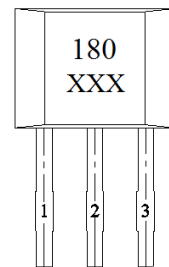


#### NOTES:

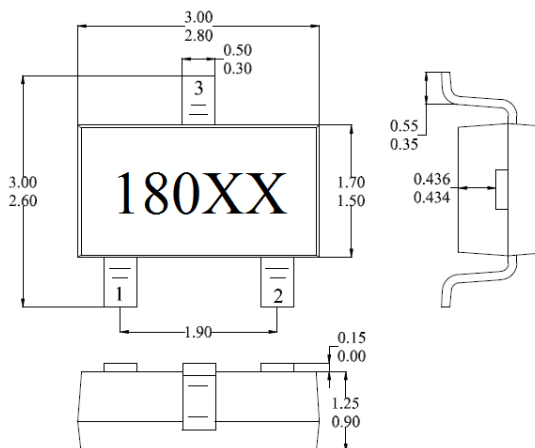
1. Controlling dimension: mm
2. Leads must be free of flash and plating voids
3. Do not bend leads within 1 mm of lead to package interface.
4. PINOUT:

Pin 1	V <sub>DD</sub>
Pin 2	GND
Pin 3	Output

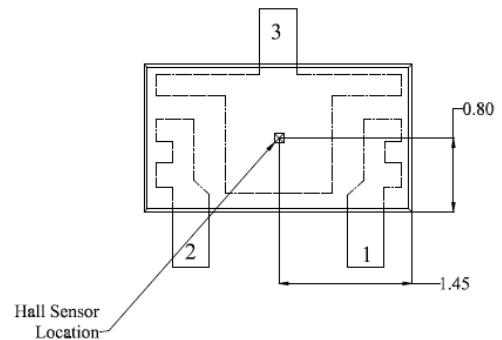
#### Output Pin Assignment (Top view)



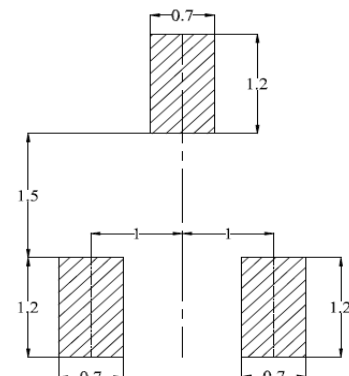
#### SO Package (Top View)



#### Hall Plate Chip Location (Bottom view)



#### (For reference only) Land Pattern



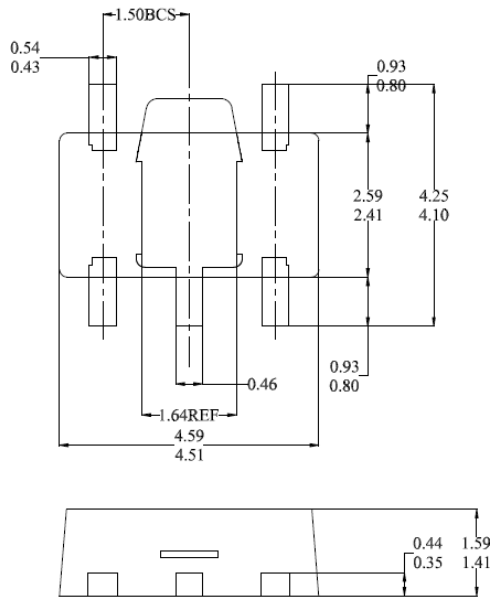
#### NOTES:

1. PINOUT (See Top View at left :)
 

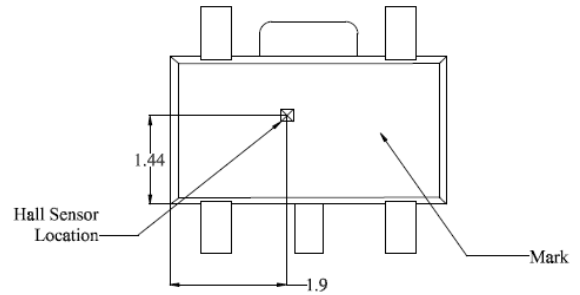
Pin 1	V <sub>DD</sub>
Pin 2	Output
Pin 3	GND
2. Controlling dimension: mm
3. Lead thickness after solder plating will be 0.254mm maximum

### SF Package (SOT-89 5 pins)

(Bottom view)

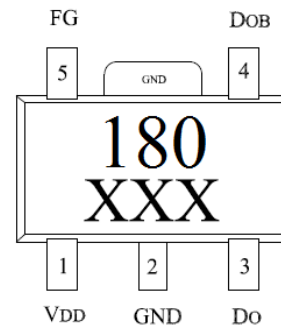


Hall Chip location



Output Pin Assignment

(Top view)



#### NOTES:

- Controlling dimension: mm
- Leads must be free of flash and plating voids
- Do not bend leads within 1 mm of lead to package interface.
- PINOUT:

Pin 1	V <sub>DD</sub>
Pin 2	GND
Pin 3	Out
Pin 4	N/A
Pin 5	N/A

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [Industrial Hall Effect/Magnetic Sensors](#) category:*

*Click to view products by [Magnesensor](#) manufacturer:*

Other Similar products are found below :

[GT-14114](#) [GT-14123](#) [GTN2C15C](#) [GT-12076](#) [GT-14049](#) [GT-14067](#) [GT-14132](#) [GT-18030](#) [PST360G2-1S-C0000-ERA360-05K](#) [MZC1-2V2PS-KP0](#) [PSC360G2-F1P-C0000-ERA360-05K-200](#) [115L 9E 502 W06017](#) [115L 5,2E 502 W06017](#) [115L 14E 502 W06017](#) [103SR14A-1](#) [55100-3H-04-A](#) [MZT7-03VPS-KR0](#) [MZT7-03VPS-KW0](#) [MZT8-03VPS-KW0](#) [MZT8-28VPS-KP0](#) [A1326LLHLT-T](#) [55505-00-02-B](#) [55100-3M-03-A](#) [GN 55.2-ND-15-3](#) [GN 55.2-ND-18-3](#) [GN 55.2-ND-4-3](#) [GN 55.2-ND-8-3](#) [GN 55.2-SC-10-3](#) [GN 55.4-ND-12-9,5-2,5](#) [GN 55.4-ND-26-20,3-5](#) [GN 55.4-ND-7,5-4-1,5](#) [101MG7-BP](#) [103SR18-1](#) [A1324LUA-T](#) [MXM1120KIT](#) [MXM1120SOKIT](#) [A3212EUA-T](#) [AA006-02E](#) [55140-3H-03-A](#) [55100-2M-02-A](#) [MM12-60APS-ZUK](#) [ACX04-F99-I-V15](#) [GN 55.1-SC-24-11.5-4](#) [MZR40158](#) [55100-2M-01-D](#) [PW520000](#) [MZT7-03VPS-KP0](#) [MZT8-03VPS-KR0](#) [RZT7-03ZRS-KP0](#) [RZT7-03ZRS-KW0](#)